

I. General

1-1 Scope

This specification apples to 16mm size low-profile rotary encoder (incremental type) for microscopic current circuits. Used in electronic equipment.

1-2 Standard atmospheric conditions

Unless otherwise specified. The standard range of atmospheric conditions for making measurements and tests is as fallows;

:

Ambient temperature

15°C to 35°C

Relative humidity

25% to 85%

Air pressure

86kPa to 106kPa

If there is any doubt about the results. measurements shall be made within the following limits:

Ambient temperature

20 ± 1°C

Relative humidity

63% to 67%

Air pressure

86kPa to 106kPa

1-3

Operating temperature range

-10°C to +70°C

1-4

Storage temperature range

-40°C to +80°C

. Construction

2-1 Dimensions

Refer to attached drawing.

3. Rating

3-1 Rated voltage

D. C. 5V

3-2 Maximum operating current (resistive load)

Each lead

0.5mA

Common lead

ImA

	Item	Conditions		Specifications	
1-1	Output signal format				2 Phase-different signals (Signa A signal B) Details shown in <fig 1="">.(The broken line shows detent</fig>
		ar' is		position)	
		<pre><fie 1="">     Shaft rotational direction</fie></pre>	Signal		Output
		C. W	A(Terminal		OFF ON
		C. W.	B(Terminal	B-C)	OFF ON
		C. C. W.	A(Terminal	A-C)	OFF ON
			B(Terminal	B-C)	OFF ON
-2	Resolution	Number of pulses in 360° rotation			24 pulses/360 for each phase
	Characteristi cs	1)Shaft rotational speed : 36 2)Test circuit :	60° ·S <sup>-1</sup> <fig.2></fig.2>		
		(note)Code-ON area : The area			less-
)	Chattering	Specified by the signal's passag			

	Item	Conditions	Specifications
2)	Sliding noise (Bounce)	Specified by the time of voltage chance exceed 1.5V in code-ON area.  When the bounce has code-ON time less than 1ms between chatterings (t <sub>1</sub> or t <sub>3</sub> ). The voltage chance shall be regarded, as a part of chattering.  When the code-ON time between 2 bounces is less than 1ms.  They are regarded as linked bounce.	t2≦2ms
3)	Sliding noise	The voltage chance in code-OFF area	3.5V MIN
4-4	Phase-difference	Measurement shall be made under the condition which the shaft is rotated in constant speed.    OFF  Signal A  OFF  Signal B  OFF  ON  OT  OT  OT  OT  OT  OT  OT  OT  OT	ΔT=0.15±0.1T In <fia.4></fia.4>
4-5	Dielectric strength	A voltage of 50V A.C. shall be applied for 1min between ndividual terminals and bushing	Without arcing or breakdown
1-6	Insulation Resistance	Measurement shall be made under the condition which a voltage of 50V D.C is applied between individual terminals and bushing	Between individual terminals and bushing, $10M\Omega$ MIN.

	Item	Conditions	Specifications
5-1	Total rotational angle		360° (Endless)
5-2	Rotation torque		50~200gf-cm( Applied for
			with detent type)
5-3	Number and		24 detents (Step angle15°±
	position of deten		3°, Applied for with deten
			type)
5-4	Push-pull	Push and pull static load of 80N shall be applied to the shaft	Without damage to. Or
	Strength of shaft	In the axial direction for 10S. (After installing)	Excessive play in shaft
			No excessive abnormality
			In rotational feline.And
			electrical Characteristics
			Shall be satisfied
5-5	Terminal strength	A static load of 3N shall be applied to the tip of terminals for	Without excessive play
		105 in any direction	Play in terminals or poor
			contact.
5-6	Shaft wobble	A momentary load of 50mN·m shall be applied at the point	0.7xL/30mmp-p MAX
		5mm from the tip of the shaft in a direction perpendicular to	(1:shaft length)
19.00		the axis of shaft.	
5-7	Shaft play in axial	Push and pull static load of 5N shall be applied to the shaft in	0.4mmp-p MAX
	Direction	the axial directions	
5-8	Side thrust strength	A load of 30N shall be applied at the point 5mm from the tip	Without excessive' play or
	of shaft	Of the shaft in a direction perpendicular to the axis of shaft	bending in shaft. No
			mechanical abnormality.
5-9	Bushing nut	Tighten the nut according to <fig.5></fig.5>	Tightening torque to be no
	tightening strength		greater than 1N.m.
		Chassis Nat	
		<fig·5></fig·5>	
5-10	Resistance to	Specified by the clause 7 Soldering conditions	Electrical Characteristics
	soldering heat		shall Be satisfied . No
			mechanical Abnormality
			such as a excessive play.

6-6 Vibration

E16	0F)	16mm Size Rotary Encoder Specification	Page:5		
6.	6. Endurance characteristics				
	Item	Conditions	Specifications		
6-1	Rotational life	The shaft of encoder shall be rotated to 50,000 cycles at a	Chattering $t_u t_s \leq 5 mS$		
		speed of 500 cycles per hour without electrical load. After	Bounce $t_2 \leq 3mS$		
		which measurements shall be made.	Except above items.		
		However an interim measurement shall be made immediately	Specifications in clause		
		after 5,000 cycles .(1 cycle: rotate 360° c.c.w and rotate 360°	4.1~4.6 and 5.1~5.3 shall be		
		cw).	satisfied.		
6-2	Damp heat	The encoder shall be stored at a temperature of 40±2°C with	Specifications in clause		
·		relative humidity of 90% to 95% for 240±10H in a	4.1~4.6 and 5.1~5.3 shall		
		thermostatic chamber. And then the encoder shall be subjected	be satisfied.		
		to standard atmospheric conditions for 1.5H. after which			
		measurements shall be made.			
6-3	Dry heat	The encoder shall be stored at a temperature of 80±3°C for 240	Specifications in clause		
	1	±10H in a thermostatic chamber. And then the encoder shall	4.1~4.6 and 5.1~5.3 shall		
		be subjected to standard atmospheric conditions for 1.5H.	be satisfied.		
		after which measurements shall be made.			
6-4	Cold	The encoder shall be stored at a temperature of -40±3°C for	Specifications in clause		
	1 TO THE PARTY OF	240±10H in a thermostatic chamber. And then the encoder	4.1~4.6 and 5.1~5.3 shall		
		shall be subjected to standard atmospheric conditions for	be satisfied.		
		1.5H. after which measurements shall be made.			
6-5	Free falling	The encoder shall be fallen freely at any posture from 60cm	No 'excessive Deformation		
	-	height to the concrete floor covered with vinyl-tile. After	or damage.(Except the		
		which measurement shall be made.	deformation of terminals .)		
			And specifications in		

The following vibration shall be applied to the encoder. After

The entire frequency range, from 10Hz to 55Hz and return to

This motion shall be applied for a period of 2H in each of 3

which measurement shall be made;

10Hz.shall be transversed in 1 min. Amplitude(total excursion):1.5mm

mutually perpendicular axes (A total of 6H).

clause 4.1~4.6 and 5.1~5.3

Specifications in clause

4.1~4.6 and 5.1~5.3 shall

shall be satisfied.

be satisfied.

## 7. Soldering conditions

#### 7-1 Manual soldering

Bit temperature of soldering iron

:350°C or less.

Application time of soldering iron

: within 3s.

Dip soldering

Printed wiring board: Single-sided copper clad laminate board with thickness of 1.6mm.

#### Flux:

·Specific gravity :0.82 or more.

Flux shall be applied to the board using a bubble foaming type fluxer.

'The board shall be soaked in the flux bubble only to the middle of its thickness.

·Flux shall not come into contact with the component side surface.

### Preheating:

·Surface temperature of board : 100°C or less.

Preheating time: within 2 min.

#### Soldering:

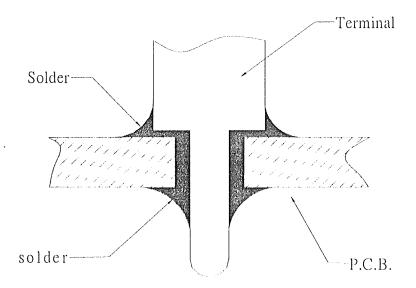
·Soldering: To be performed in 10 seconds within 260°C±5°C.

Manual soldering condition: to be performed in 3 seconds within350±5℃

Apply the above soldering process for 1 or 2 times.

8. Note for soldering method.

Please avoid soldering on upper surface (the component side surface) of the PC board as shown below.



# Common Specification of Variable Resistor (RoHS) VR 共通規格書(RoHS compliant version)

1 Soldering conditions

無鉛銲錫條件

Soldering shall be certified with following condition.

作銲錫處理時,請確保在下列工作條件。

1-1 Substrate to be soldered: Copper clad laminated phenol board of 1.6mm thickness.

使用基板: t 1.6 mm 銅箔積層板。

1-2 Solder Flux: Flux of 0.82 specific weight in bubbling type solder flux coating apparatus shall be used and bubbling surface height shall be defined substantially as half thickness of substrate. Flux shall not flow up on the substrate surface.

助銲劑:使用發泡式比重 0.82 以上的銲劑,發泡面高大致在基板厚度一半的位置,而助銲劑不可流入基板表面上。

1-3 Preheating: Surface temperature of the substrate shall be settled within 100°C in two minutes.

預熱:基板表面溫度 100℃以下,2分鐘以內。

1-4 Soldering: To be performed in 10 seconds within 260°C. (Belongs to terminal the surface)

銲錫:260℃以下,10秒以內。(屬於端子面)

(This item of soldering tin temperature condition ill uses in wave ridge soldering tin work equipment or reflow soldering tin work equipment)

(本項焊錫溫度條件不適用於波峰焊錫作業設備或回流焊錫作業設備)

1-5 Manual soldering condition: to be performed in 3 seconds within 350±5°C

手銲:350±5°C,3秒以內。

Please process the above procedure no more than 2 times.

以上工程1回或2回通過即可。

Above for the common soldering tin work condition, the use high temperature soldering tin work equipment invites other to propose the demand.

以上爲一般焊錫作業條件,使用高溫焊錫作業設備請另外提出需求.